



# Intel<sup>®</sup> E7505 Chipset Memory Controller Hub (MCH)

Specification Update

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*December 2002*

**Notice:** The Intel<sup>®</sup> E7505 MCH may contain design defects or errors known as errata which may cause the product to deviate from published specifications. Current characterized errata are documented in this Specification Update.

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## Revision History

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Revision	Description	Date
-001	Initial Release	November 2002
-002	Updated Erratum E1 and E2 Updated Component Marking Information Updated Affected Documents/Related Documents section	December 2002

# Preface

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This document is an update to the specifications contained in the documents listed in the following Affected Documents/Related Documents table. It is a compilation of device and document errata and specification clarifications and changes, and is intended for hardware system manufacturers and for software developers of applications, operating system, and tools.

Information types defined in the Nomenclature section of this document are consolidated into this update document and are no longer published in other documents. This document may also contain information that has not been previously published.

### Affected Documents/Related Documents

Document Title	Document Number
Intel® E7505 Chipset Memory Controller Hub (MCH) Datasheet	251932-002

## Nomenclature

**Specification Changes** are modifications to the current published specifications. These changes will be incorporated in the next release of the specifications.

**Errata** are design defects or errors. Errata may cause the behavior of the Intel® E7505 chipset MCH to deviate from published specifications. Hardware and software designed to be used with any given stepping must assume that all errata documented for that stepping are present on all devices.

**Specification Clarifications** describe a specification in greater detail or further highlight a specification's impact to a complex design situation. These clarifications will be incorporated in the next release of the specifications.

**Documentation Changes** include typos, errors, or omissions from the current published specifications. These changes will be incorporated in the next release of the specifications.

## Component Identification via Programming Interface

The E7505 chipset MCH stepping can be identified by the following register contents:

Stepping	Vendor ID <sup>1</sup>	Device ID <sup>2</sup>	Revision Number <sup>3</sup>
B0	8086h	2550h	03h

**NOTES:**

1. The Vendor ID corresponds to bits 15:0 of the Vendor ID Register located at offset 00–01h in the PCI function 0 configuration space.
2. The Device ID corresponds to bits 15:0 of the Device ID Register located at offset 02–03h in the PCI function 0 configuration space.
3. The Revision Number corresponds to bits 7:0 of the Revision ID Register located at offset 08h in the PCI function 0 configuration space.

## Component Marking Information

The E7505 chipset MCH may be identified by the following component markings:

Stepping	S-Spec	Top Marking	Notes
B0	SL65N	RGE7505MC	1
B0	SL6TU	RGE7505MC	2

**NOTES:**

1. This S-Spec corresponds to E7505 chipset memory controller hub parts with a VCC= 1.2 V
2. This S-Spec corresponds to E7505 chipset memory controller hub parts with a VCC= 1.3 V

## Summary Tables of Changes

The following table indicates the Specification Changes, Errata, Specification Clarifications or Documentation Changes, which apply to the listed Intel® E7505 chipset MCH steppings. Intel intends to fix some of the errata in a future stepping of the component, and to account for the other outstanding issues through documentation or Specification Changes as noted. This table uses the following notations:

### Codes Used in Summary Table

- X: Erratum, Specification Change or Clarification that applies to this stepping.
- Doc: Document change or update that will be implemented.
- PlanFix: This erratum may be fixed in a future stepping of the product.
- Fixed: This erratum has been previously fixed.
- NoFix: There are no plans to fix this erratum.
- (No mark) or (Blank Box): This erratum is fixed in listed stepping or specification change does not apply to listed stepping.

**Shaded:** This item is either new or modified from the previous version of the document.

Number	B0	Plans	ERRATA
E1	X	NoFix	tVAL(min) Timing Is Not Meeting AGP 3.0 Specification
E2	X	NoFix	AGP Prefetch Cache Must Be Disabled

Number	SPECIFICATION CHANGES
1	There are no Specification Changes in this Specification Update revision.

Number	SPECIFICATION CLARIFICATIONS
	There are no Specification Clarifications in this Specification Update revision.

Number	DOCUMENTATION CHANGES
	There are no Documentation Changes in this Specification Update revision



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## Errata

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### 1. tVAL(min) Timing Is Not Meeting AGP 3.0 Specification

**Problem:** During simulation studies, it was determined that the AGP signals were not meeting the tVAL(min) of 1 ns.

**Implication:** AGP interface is susceptible to latching invalid data.

**Workaround:** Minimum trace lengths for the AGP common clock and source synchronous signals have increased to offset this timing violation. Refer to latest platform design guide.

**Status:** No fix planned for this erratum. Issue resolved by board workaround.

### 2. AGP Prefetch Cache Must Be Disabled

**Problem:** System hangs can occur during AGP transactions when the AGP Prefetcher is enabled.

**Implication:** System hangs.

**Workaround:** Disable AGP Prefetch Cache by clearing bit 0 of AGP Miscellaneous Register (Device 1 Function 0 Offset A0–A3h).

**Status:** No fix planned for this erratum. System performance is not affected by this erratum



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## ***Specification Changes***

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There are no Specification Changes in this Specification Update revision.



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## ***Specification Clarifications***

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There are no specification clarifications in this Specification Update revision.



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## ***Documentation Changes***

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There are no Documentation Changes in this Specification Update revision.